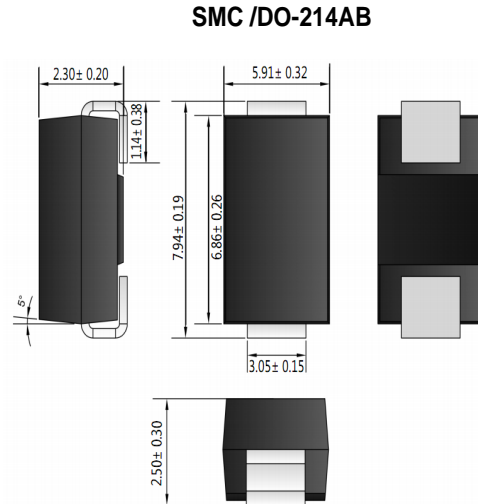


**3.0A SURFACE MOUNT GLASS PASSIVATED SUPERFAST DIODE**
**Features**

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop, High Efficiency
- Surge Overload Rating to 100A Peak
- Low Power Loss
- Super-Fast Recovery Time
- Ideally Suited for Use in High Frequency SMPS, Inverters and As Free Wheeling Diodes

**Mechanical Data**

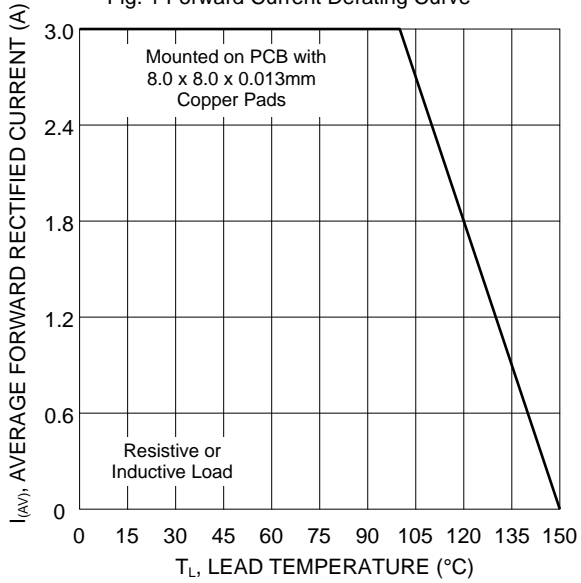
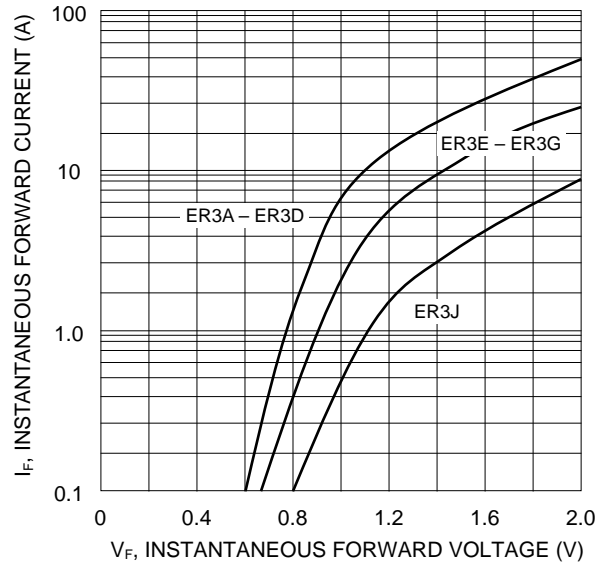
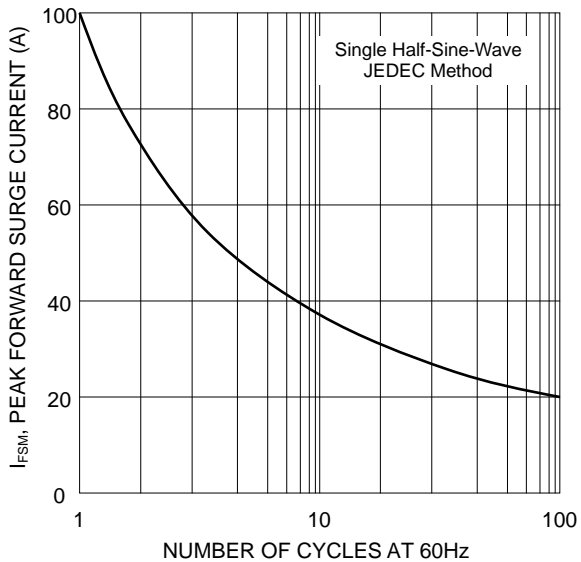
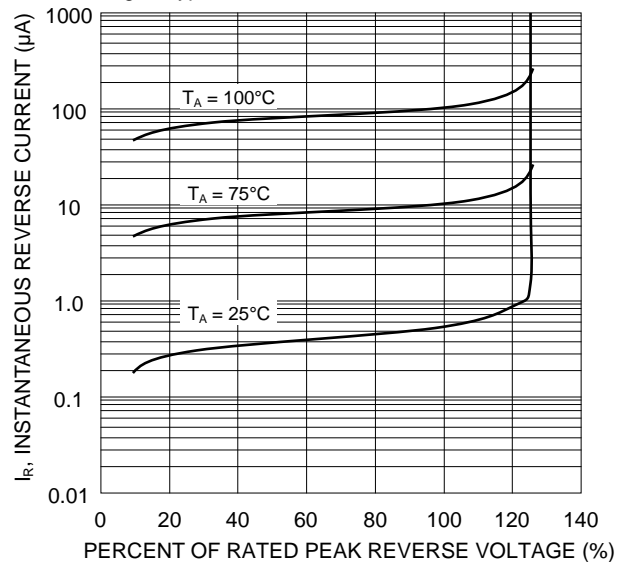
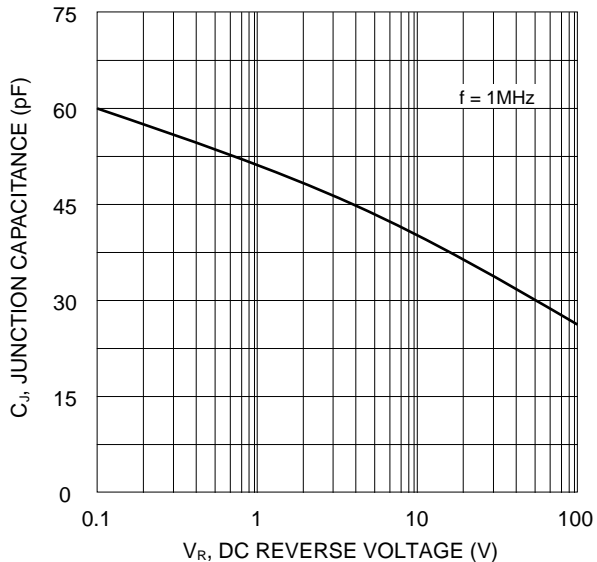
- Case: SMC/DO-214AB, Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Weight: 0.21 grams (approx.)
- **Lead Free: For RoHS / Lead Free Version**


**Maximum Ratings and Electrical Characteristics** @ $T_A=25^{\circ}\text{C}$  unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

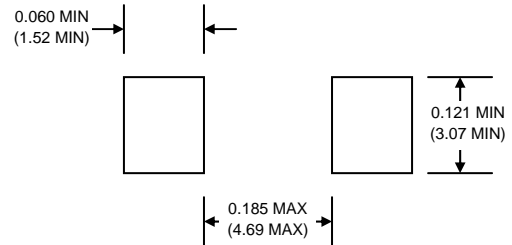
Characteristic	Symbol	ER3A	ER3B	ER3C	ER3D	ER3E	ER3G	ER3J	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$								
Working Peak Reverse Voltage	$V_{RWM}$	50	100	150	200	300	400	600	V
DC Blocking Voltage	$V_R$								
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	105	140	210	280	420	V
Average Rectified Output Current @ $T_L = 100^{\circ}\text{C}$	$I_O$	3.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	100							A
Forward Voltage @ $I_F = 3.0\text{A}$	$V_{FM}$	0.95				1.25		1.7	V
Peak Reverse Current @ $T_A = 25^{\circ}\text{C}$ At Rated DC Blocking Voltage @ $T_A = 100^{\circ}\text{C}$	$I_{RM}$	10				500			$\mu\text{A}$
Reverse Recovery Time (Note 1)	$t_{rr}$	35							nS
Typical Junction Capacitance (Note 2)	$C_J$	45							pF
Thermal Resistance Junction to Ambient (Note 3)	$R_{JA}$	50							$^{\circ}\text{C}/\text{W}$
Thermal Resistance Junction to Lead (Note 3)	$R_{JL}$	15							
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150							$^{\circ}\text{C}$

Note: 1. Measured with  $I_F = 0.5\text{A}$ ,  $I_R = 1.0\text{A}$ ,  $I_{RR} = 0.25\text{A}$ .  
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC.  
 3. Mounted on PCB with 8.0mm x 8.0mm x 0.013mm thick copper pads.

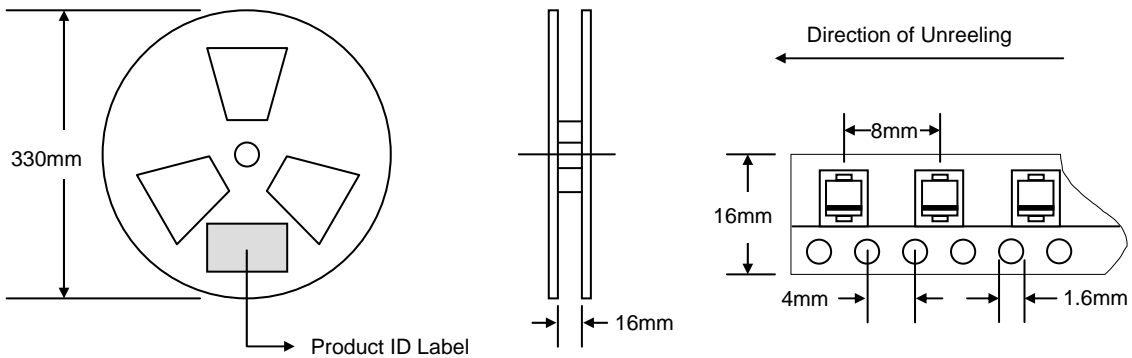
**Fig. 1 Forward Current Derating Curve**

**Fig. 2 Typical Forward Characteristics**

**Fig. 3 Forward Surge Current Derating Curve**

**Fig. 4 Typical Reverse Characteristics**

**Fig. 5 Typical Junction Capacitance**


**MARKING INFORMATION**


Cathode = Polarity Band  
 ER3x = Device Number  
 x = A, B, C, D, E, G or J

**RECOMMENDED FOOTPRINT**


inches(mm)

**PACKAGING INFORMATION**
**TAPE & REEL**


Reel Diameter (mm)	Quantity (PCS)	Inner Box Size L x W x H (mm)	Quantity (PCS)	Carton Size L x W x H (mm)	Quantity (PCS)	Approx. Gross Weight (KG)
330	3,000	340 x 337 x 45	6,000	370 x 370 x 420	48,000	19.0

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